PIC14C000

EPROM Memory Programming Specification

This document includes the programming specifications for the following devices:

- PIC14C000

1.0 PROGRAMMING THE PIC14C000

The PIC14C000 can be programmed using a serial method. In serial mode the PIC14C000 can be programmed while in the users system. This allows for increased design flexibility. This programming specification applies to PIC14C000 devices in all packages.

1.1 Hardware Requirements

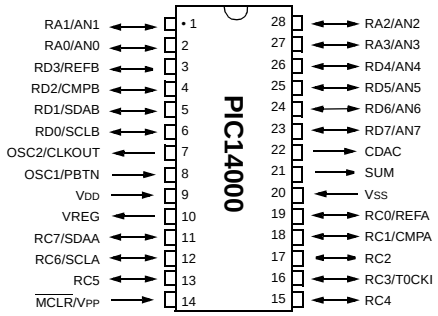
The PIC14C000 requires two programmable power supplies, one for VDD (2.0V to 6.5V recommended) and one for VPP (12V to 14V).

1.2 Programming Mode

The programming mode for the PIC14C000 allows programming of user program memory, configuration word, and calibration memory.

PIN DIAGRAM

PDIP, SOIC, SSOP, Windowed CERDIP



2.0 PROGRAM MODE ENTRY

2.1 User Program Memory Map

The program and calibration memory space extends from 0x000 to 0xFFF (4096 words). Table 2-1 shows actual implementation of program memory in the PIC14C000.

TABLE 2-1: IMPLEMENTATION OF PROGRAM AND CALIBRATION MEMORY IN THE PIC14C000P

Area	Memory Space	Access to Memory
Program	0x000-0xFBF	PC<12:0>
Calibration	0xFC0 -0xFFF	PC<12:0>

When the PC reaches address 0xFFF, it will wrap around and address a location within the physically implemented memory (see Figure 2-1).

In programming mode the program memory space extends from 0x0000 to 0x3FFF, with the first half (0x0000-0x1FFF) being user program memory and the second half (0x2000-0x3FFF) being configuration memory. The PC will increment from 0x0000 to 0x1FFF and wrap to 0x0000, or 0x2000 to 0x3FFF and wrap around to 0x2000 (not to 0x0000). Once in configuration memory, the highest bit of the PC stays a '1', thus always pointing to the configuration memory. The only way to point to user program memory is to reset the part and reenter program/verify mode, as described in Section 2.2.

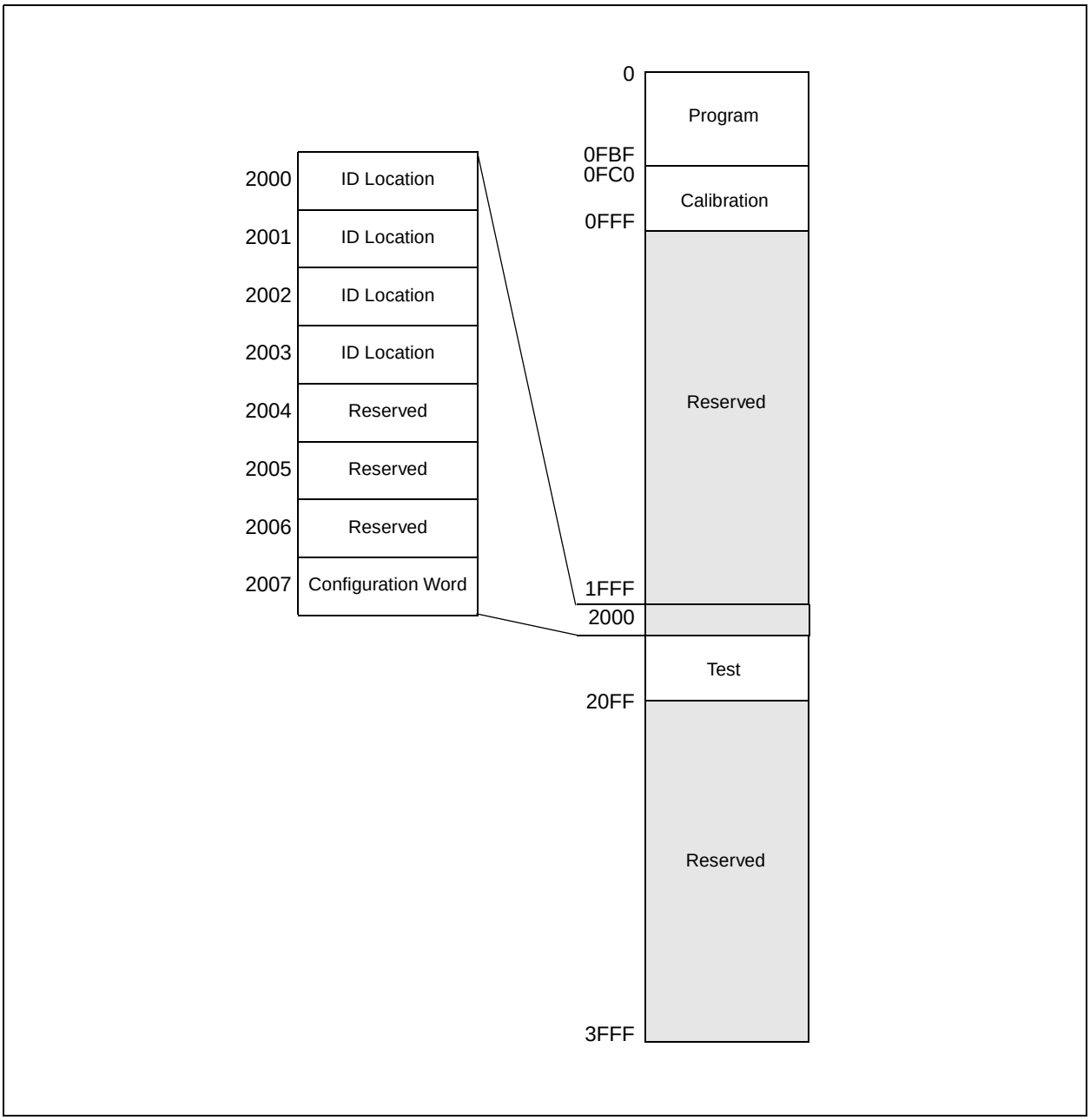
In the configuration memory space, 0x2000-0x20FF are utilized. When in configuration memory, as in the user memory, the 0x2000-0x2XFF segment is repeatedly accessed as PC exceeds 0x2XFF (Figure 2-1).

A user may store identification information (ID) in four ID locations. The ID locations are mapped in [0x2000 : 0x2003]. All other locations are reserved and should not be programmed.

The ID locations read out normally, even after code protection. To understand how the devices behave, refer to Table 4-1.

To understand the scrambling mechanism after code protection, refer to Section 4.1.

FIGURE 2-1: PROGRAM MEMORY MAPPING



2.2 Program/Verify Mode

The program/verify mode is entered by holding pins RC6 and RC7 low while raising MCLR pin from VIL to VIHH (high voltage). Once in this mode the user program memory and the configuration memory can be accessed and programmed in serial fashion. The mode of operation is serial, and the memory that is accessed is the user program memory. RC6 and RC7 are both Schmitt Trigger inputs in this mode.

The sequence that enters the device into the programming/verify mode places all other logic into the reset state (the MCLR pin was initially at VIL). This means that all I/O are in the reset state (High impedance inputs).

Note:	The MCLR pin should be raised as quickly as possible from VIL to VIHH. This is to ensure that the device does not have the PC incremented while in valid operation range.

2.2.1 PROGRAM/VERIFY OPERATION

The RB6 pin is used as a clock input pin, and the RB7 pin is used for entering command bits and data input/output during serial operation. To input a command, the clock pin (RC6) is cycled six times. Each command bit is latched on the falling edge of the clock with the least significant bit (LSB) of the command being input first. The data on pin RC7 is required to have a minimum setup and hold time (see AC/DC specs) with respect to the falling edge of the clock. Commands that have data associated with them (read and load) are specified to have a minimum delay of 1µs between the command and the data. After this delay the clock pin is cycled 16 times with the first cycle being a start bit and the last cycle being a stop bit. Data is also input and output LSB first. Therefore, during a read operation the LSB will be transmitted onto pin RC7 on the rising edge of the second cycle, and during a load operation the LSB will be latched on the falling edge of the second cycle. A minimum 1µs delay is also specified between consecutive commands.

All commands are transmitted LSB first. Data words are also transmitted LSB first. The data is transmitted on the rising edge and latched on the falling edge of the clock. To allow for decoding of commands and reversal of data pin configuration, a time separation of at least 1µs is required between a command and a data word (or another command).

The commands that are available are listed in Table .

2.2.1.1 LOAD CONFIGURATION

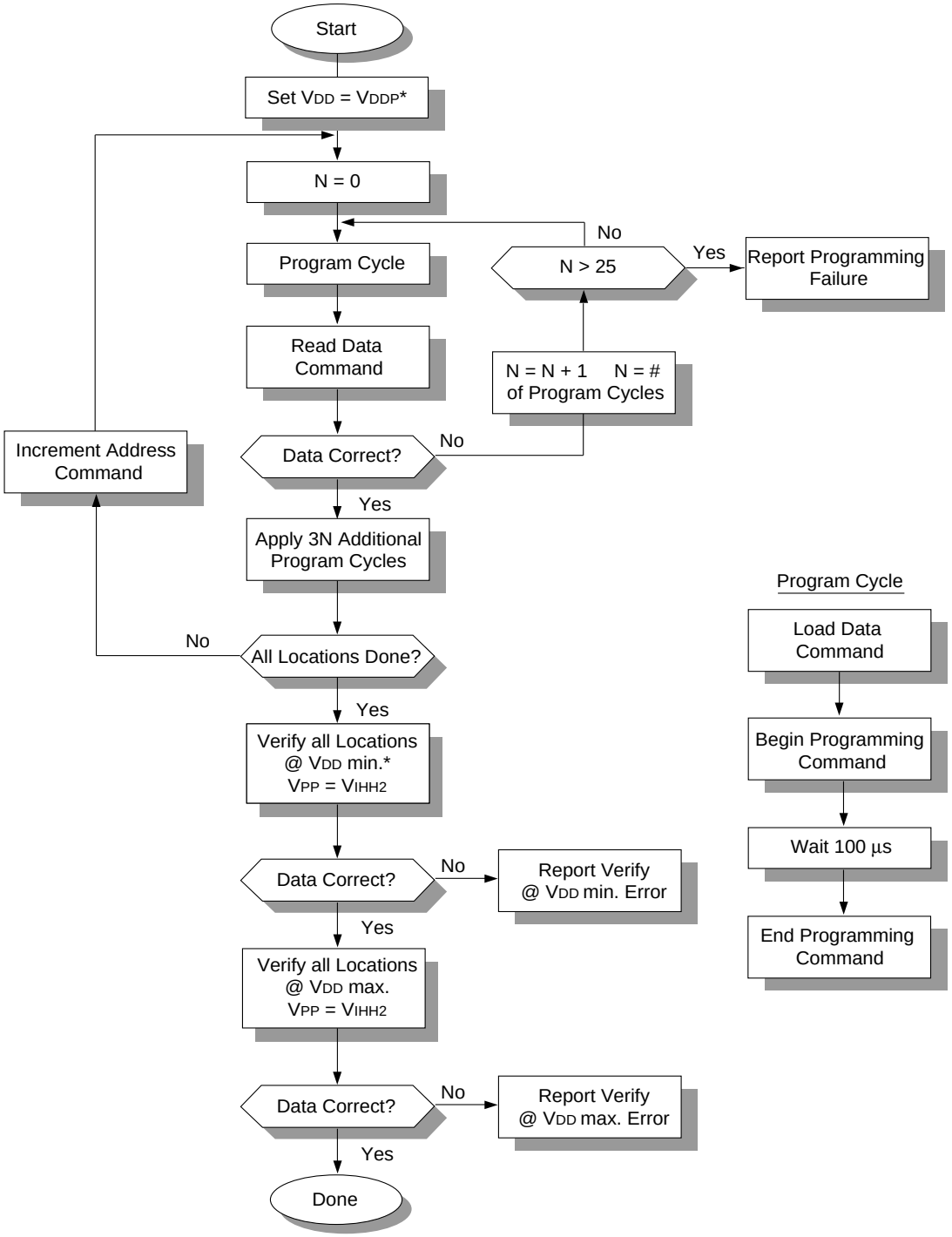
After receiving this command, the program counter (PC) will be set to 0x2000. By then applying 16 cycles to the clock pin, the chip will load 14-bits a “data word” as described above, to be programmed into the configuration memory. A description of the memory mapping schemes for normal operation and configuration mode operation is shown in Figure 2-1. After the configuration memory is entered, the only way to get back to the user program memory is to exit the program/verify test mode by taking $\overline{MCLR}$ low (V_{IL}).

TABLE 2-1: COMMAND MAPPING

Command	Mapping (MSB ... LSB)						Data
Load Configuration	0	0	0	0	0	0	0, data(14), 0
Load Data	0	0	0	0	1	0	0, data(14), 0
Read Data	0	0	0	1	0	0	0, data(14), 0
Increment Address	0	0	0	1	1	0	
Begin programming	0	0	1	0	0	0	
End Programming	0	0	1	1	1	0	

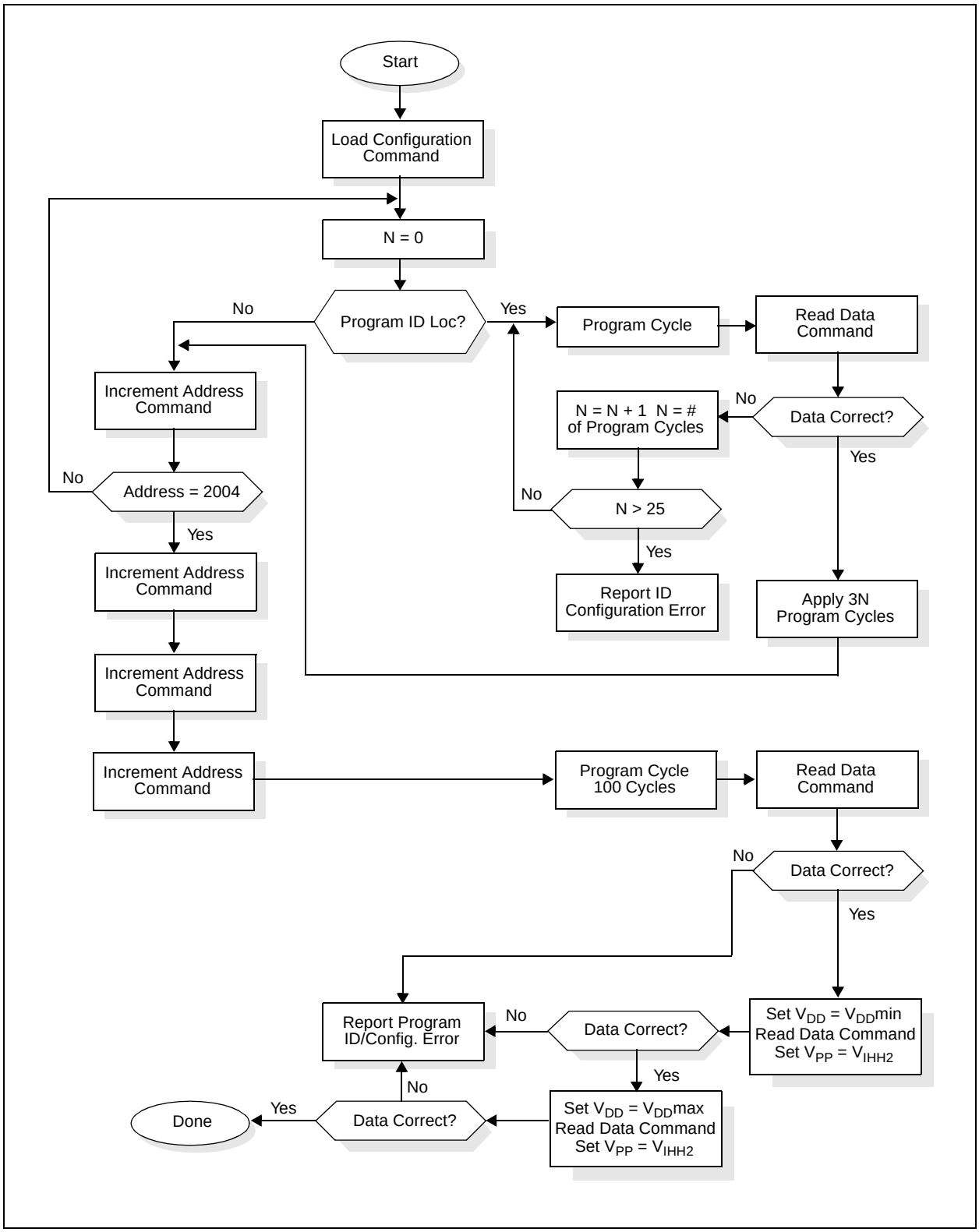
Note: The CPU clock must be disabled during in-circuit programming (to avoid incrementing the PC).

FIGURE 2-2: PROGRAM FLOW CHART - PIC14C000 PROGRAM MEMORY AND CALIBRATION



* VDDP = VDD range for programming (typically 4.75V - 5.25V).
VDDmin = Minimum VDD for device operation.
VDDmax = Maximum VDD for device operation.

FIGURE 2-3: PROGRAM FLOW CHART - PIC14C000 CONFIGURATION WORD & ID LOCATIONS



2.2.1.2 LOAD DATA

After receiving this command, the chip will load in a 14-bit “data word” when 16 cycles are applied, as described previously. A timing diagram for the load data command is shown in Figure 5-1.

2.2.1.3 READ DATA

After receiving this command, the chip will transmit data bits out of the memory currently accessed starting with the second rising edge of the clock input. The RC7 pin will go into output mode on the second rising clock edge, and it will revert back to input mode (hi-impedance) after the 16th rising edge. A timing diagram of this command is shown in Figure 5-2.

2.2.1.4 INCREMENT ADDRESS

The PC is incremented when this command is received. A timing diagram of this command is shown in Figure 5-3.

2.2.1.5 BEGIN PROGRAMMING

A load command (load configuration or load data) must be given before every begin programming command. Programming of the appropriate memory (test program memory or user program memory) will begin after this command is received and decoded. Programming should be performed with a series of 100μs programming pulses. A programming pulse is defined as the time between the begin programming command and the end programming command.

2.2.1.6 END PROGRAMMING

After receiving this command, the chip stops programming the memory (configuration program memory or user program memory) that it was programming at the time.

2.3 Programming Algorithm Requires Variable V_{DD}

The PIC14C000 uses an intelligent algorithm. The algorithm calls for program verification at V_{DD}min as well as V_{DD}max. Verification at V_{DD}min guarantees good “erase margin”. Verification at V_{DD}max guarantees good “program margin”.

The actual programming must be done with V_{DD} in the V_{DDP} range (4.75 - 5.25V).

V_{DDP} = V_{CC} range required during programming.

V_{DD}min = minimum operating V_{DD} spec for the part.

V_{DD}max = maximum operating V_{DD} spec for the part.

Programmers must verify the PIC14C000 at its specified V_{DD}max and V_{DD}min levels. Since Microchip may introduce future versions of the PIC14C000 with a broader V_{DD} range, it is best that these levels are user selectable (defaults are ok).

Note:	Any programmer not meeting these requirements may only be classified as “prototype” or “development” programmer but not a “production” quality programmer.

3.0 CONFIGURATION WORD

The PIC14C000 has several configuration bits. These bits can be programmed (reads '0') or left unprogrammed (reads '1') to select various device configurations. Figure 3-1 provides an overview of configuration bits.

FIGURE 3-1: CONFIGURATION WORD BIT MAP

Bit Number:	13	12	11	10	9	8	7	6	5	4	3	2	1	0
PIC14C000	CPC	CPP1	CPP0	CPP0	CPP1	CPC	CPC	F	CPP1	CPP0	PWRTE	WDTE	F	FOSC

CPP<1:0>
- 11: All Unprotected
- 10: N/A
- 01: N/A
- 00: All Protected

bit 1,6: **F** Internal trim, factory programmed. DO NOT CHANGE! Program as '1'. Note 1.

bit 3: **$\overline{\text{PWRTE}}$**, Power Up Timer Enable Bit
- 0 = Power up timer enabled
- 1 = Power up timer disabled (unprogrammed)

bit 2: **WDTE**, WDT Enable Bit
- 0 = WDT disabled
- 1 = WDT enabled (unprogrammed)

bit 0: **FOSC<1:0>**, Oscillator Selection Bit
- 0: HS oscillator (crystal/resonator)
- 1: Internal RC oscillator (unprogrammed)

Note 1: See Section 4.1.2 for cautions.

4.0 CODE PROTECTION

The memory space in the PIC14C000 is divided into two areas: program space (0-0xFBF) and calibration space (0xFC0-0xFFF).

For program space or user space, once code protection is enabled, all protected segments read '0's (or "garbage values") and are prevented from further programming. All unprotected segments, including ID locations and configuration word, read normally. These locations can be programmed.

4.1 Calibration Space

The calibration space can contain factory-generated and programmed values. For non-JW devices, the CPC bits in the configuration word are set to '0' at the factory, and the calibration data values are write-protected; they may still be read out, but not programmed. JW devices contain the factory values, but DO NOT have the CPC bits set.

Microchip does not recommend setting code protect bits in windowed devices to '0'. Once code-protected, the device cannot be reprogrammed.

4.1.1 CALIBRATION SPACE CHECKSUM

The data in the calibration space has its own checksum. When properly programmed, the calibration memory will always checksum to 0x0000. When this checksum is 0x0000, and the checksum of memory [0x0000:0xFBF] is 0x2FBF, the part is effectively blank, and the programmer should indicate such.

If the CPC bits are set to '1', but the checksum of the calibration memory is 0x0000, the programmer should NOT program locations in the calibration memory space, even if requested to do so by the operator. This would be the case for a new JW device.

If the CPC bits are set to '1', and the checksum of the calibration memory is NOT 0x0000, the programmer is allowed to program the calibration space as directed by the operator.

The calibration space contains specially coded data values used for device parameter calibration. The programmer may wish to read these values and display them for the operator's convenience. For further information on these values and their coding, refer to AN621 (DS00621B).

4.1.2 REPROGRAMMING CALIBRATION SPACE

The operator should be allowed to read and store the data in the calibration space, for future reprogramming of the device. This procedure is necessary for reprogramming a windowed device, since the calibration data will be erased along with the rest of the memory. When saving this data, Configuration Word <1,6> must also be saved, and restored when the calibration data is reloaded.

4.2 Embedding Configuration Word and ID Information in the Hex File

To allow portability of code, the programmer is required to read the configuration word and ID locations from the hex file when loading the hex file. If configuration word information was not present in the hex file then a simple warning message may be issued. Similarly, while saving a hex file, configuration word and ID information must be included. An option to not include this information may be provided.

Microchip Technology Inc. feels strongly that this feature is important for the benefit of the end customer.

TABLE 4-1: CODE PROTECT OPTIONS

- Protect calibration memory
  `0XXXX00XXXXXXX`
- Protect program memory
  `X0000XXX00XXXX`
- No code protection
  `1111111X11XXXX`

Program Memory Segment	R/W in Protected Mode	R/W in Unprotected Mode
Configuration Word (0x2007)	Read Unscrambled, Write Enabled	Read Unscrambled, Write Enabled
Unprotected memory segment	Read Unscrambled, Write Enabled	Read Unscrambled, Write Enabled
Protected memory segment	Read All 0's, Write Disabled	Read Unscrambled, Write Enabled
Protected calibration memory	Read Unscrambled, Write Disabled	Read Unscrambled, Write Enabled
ID Locations (0x2000 : 0x2003)	Read Unscrambled, Write Enabled	Read Unscrambled, Write Enabled

Legend: X = Don't care

4.3 Checksum

4.3.1 CHECKSUM CALCULATIONS

Checksum is calculated by reading the contents of the PIC14C000 memory locations and adding up the opcodes up to the maximum user addressable location, 0xFBF. Any carry bits exceeding 16-bits are neglected. Finally, the configuration word (appropriately masked) is added to the checksum. Checksum computation for the PIC14C000 device is shown in Table 4-2:

The checksum is calculated by summing the following:

- The contents of all program memory locations
- The configuration word, appropriately masked
- Masked ID locations (when applicable)

The least significant 16 bits of this sum is the checksum.

The following table describes how to calculate the checksum for each device. Note that the checksum calculation differs depending on the code protect setting. Since the program memory locations read out differently depending on the code protect setting, the table describes how to manipulate the actual program memory values to simulate the values that would be read from a protected device. When calculating a checksum by reading a device, the entire program memory can simply be read and summed. The configuration word and ID locations can always be read.

Note that some older devices have an additional value added in the checksum. This is to maintain compatibility with older device programmer checksums.

TABLE 4-2: CHECKSUM COMPUTATION

Code Protect	Checksum*	Blank Value	0x25E6 at 0 and max address
OFF	SUM[0000:0FBF] + CFGW & 0x3FBD	0x2FFD	0xFBCB
OFF OTP	SUM[0000:0FBF] + CFGW & 0x3FBD	0x0E7D	0xDA4B
ON	CFGW & 0x3FBD + SUM(IDs)	0x300A	0xFBD8

Legend: CFGW = Configuration Word
SUM[A:B] = [Sum of locations a through b inclusive]
SUM(ID) = ID locations masked by 0x7F then made into a 28-bit value with ID0 as the most significant byte
*Checksum = [Sum of all the individual expressions] MODULO [0xFFFF]
+ = Addition
& = Bitwise AND

5.0 PROGRAM/VERIFY MODE ELECTRICAL CHARACTERISTICS

TABLE 5-1: AC/DC CHARACTERISTICS
AC/DC TIMING REQUIREMENTS FOR PROGRAM/VERIFY MODE

Standard Operating Conditions Operating Temperature: +10°C ≤ TA ≤ +40°C, unless otherwise stated, (25°C recommended) Operating Voltage: 4.5V ≤ VDD ≤ 5.5V, unless otherwise stated.							
Parameter No.	**Sym.**	**Characteristic**	**Min.**	**Typ.**	**Max.**	**Units**	**Conditions**
General							
PD1	VDDP	Supply voltage during programming	4.75	5.0	5.25	V	
PD2	IDDP	Supply current (from VDD) during programming	–	–	20	mA	
PD3	VDDV	Supply voltage during verify	VDDmin		VDDmax	V	Note 1
PD4	VIHH1	Voltage on $\overline{MCLR}$/VPP during programming	12.75	–	13.25	V	Note 2
PD5	VIHH2	Voltage on $\overline{MCLR}$/VPP during verify	VDD + 4.0		13.5		
PD6	IPP	Programming supply current (from VPP)	–	–	50	mA	
PD9	VIH1	(RC6, RC7) input high level	0.8 VDD	–	–	V	Schmitt Trigger input
PD8	VIL1	(RC6, RC7) input low level	0.2 VDD	–	–	V	Schmitt Trigger input
Serial Program Verify							
P1	TR	$\overline{MCLR}$/VPP rise time (VSS to VHH) for test mode entry	–	–	8.0	µs	
P2	Tf	$\overline{MCLR}$ Fall time	–	–	8.0	µs	
P3	Tset1	Data in setup time before clock ↓	100	–	–	ns	
P4	Thld1	Data in hold time after clock ↓	100	–	–	ns	
P5	Tdly1	Data input not driven to next clock input (delay required between command/data or command/command)	1.0	–	–	µs	
P6	Tdly2	Delay between clock ↓ to clock ↑ of next command or data	1.0	–	–	µs	
P7	Tdly3	Clock ↑ to date out valid (during read data)	200	–	–	ns	
P8	Thld0	Hold time after $\overline{MCLR}$ ↑	2	–	–	µs	

Note 1: Program must be verified at the minimum and maximum VDD limits for the part.
Note 2: VIHH must be greater than VDD + 4.5V to stay in programming/verify mode.

FIGURE 5-1: LOAD DATA COMMAND (PROGRAM/VERIFY)

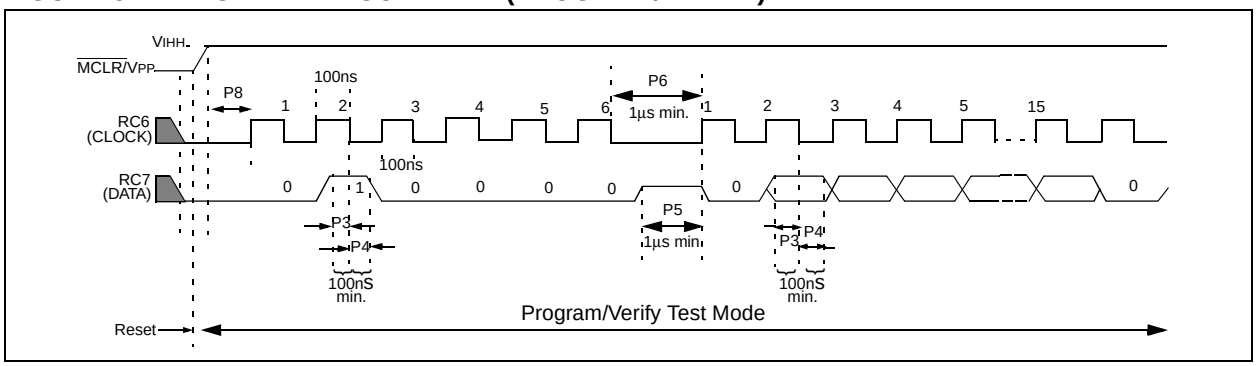


FIGURE 5-2: READ DATA COMMAND (PROGRAM/VERIFY)

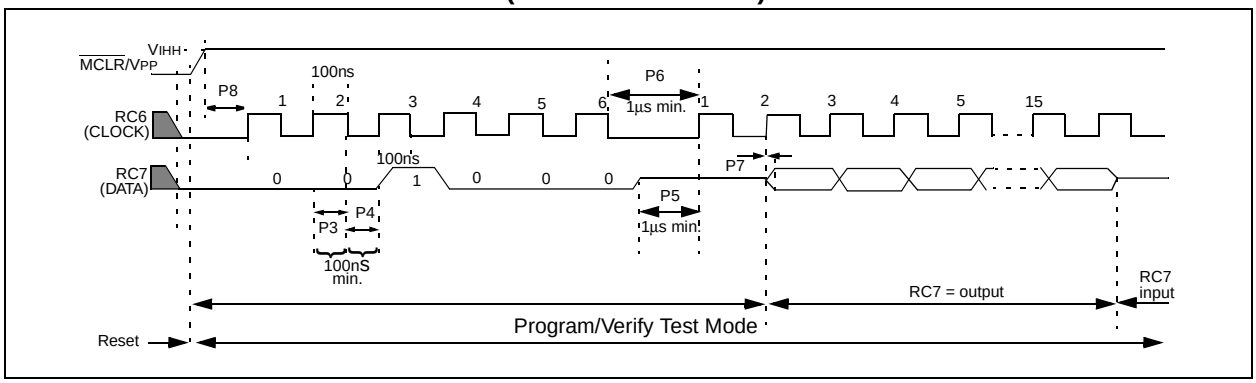
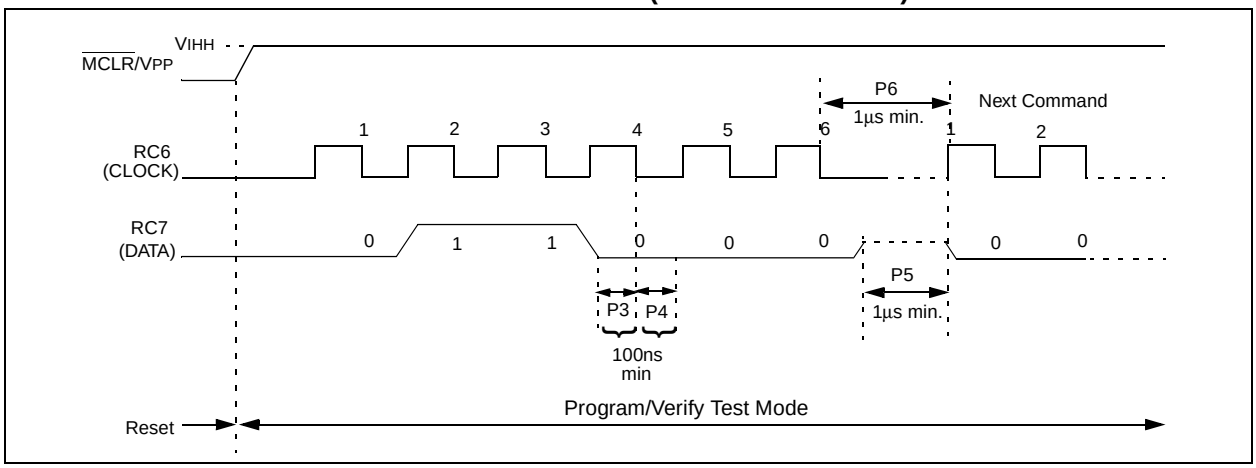


FIGURE 5-3: INCREMENT ADDRESS COMMAND (PROGRAM/VERIFY)



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